

Technology Enhancements and New Applications for VCSELS

EPIC Meeting on VCSEL Technology and Applications

Mary Hibbs-Brenner | October 17, 2019 |

Light is OSRAM



Agenda

- Vixar Inc / OSRAM Company Overview
- 2 Vixar Product Overview
- 3 High Volume 940nm/850nm Applications
- 4 Alternate VCSEL Technology and Applications
- 5 Future challenges



Key figures for financial year 2018

Revenue FY18 3.8 bn

Patents & patent applications 17,800

R&D \$\frac{1}{2}\$ 10.2% of revenue

Adj. EBITDA/
margin FY18

Global
presence

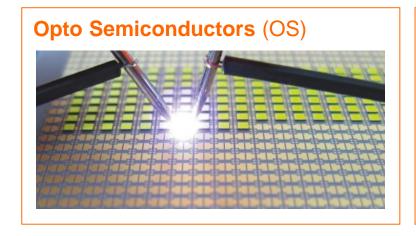
Employees
worldwide

Adj. EBITDA/
margin FY18

€622 m €16.4%

120 countries

~26,200







Figures for continued operations FY18 (per 09/30/2018), employee figure as FTE per 09/30/2018



OSRAM OS at a glance

Industry position



Market size in €bn¹) 17 9 22

Revenue 2018

No. 1 in Automotive²⁾



€1.7 bn

Employees worldwide

~13,300

Segment Automotive ~50% of revenue





1) Packaged LED (Visible + IR); 2) Packaged LED (Visible); Source: IHS Markit, Technology Group, LED Intelligence Service 2018. Data is not an endorsement



OSRAM Opto Semiconductors Key locations and key markets worldwide

USA | NAFTA Sunnyvale | Novi | Exeter

Headquarters NAFTA

- Sales and Marketing
- Application Centers

NAFTA I

 Foundry Operations Fully owned subsidiary

• LED Preproduct Production

Europe | EEM Regensburg

Global Headquarters, R+D

- Chip Production
- OLED Production
- Sales and Marketing
- Application Centers

Asia | China Hong Kong I Shanghai I Wuxi | Taiwan

Headquarters Asia Pacific

- LED Assembly, R+D
- · Sales and Marketing
- Application Centers

Asia | Japan Yokohama

- Sales and Marketing
- Application Centers



Asia | Malaysia Penang | Kulim

GL Headquarters

- Chip Production
- LED assembly
- R+D

OSRAM Acquired Vixar in July 2018

VIXAR INC.



- ✓ VCSEL Design expertise
- ✓ Design for reliability
- ✓ Dual outsourced manufacturing partners
- ✓ Packaging expertise

Technology and Operational Excellence



- ✓ High performance, high volume VCSEL products
- ✓ High quality, high reliable VCSEL products
- √ Robust dual and triple sourced supply chain
- √ Best in class package options

OSRAM OS



- ✓ High volume manufacturing expertise
- Experienced quality systems organization
- ✓ Internal Wafer and Packaging production
- ✓ Packaging expertise

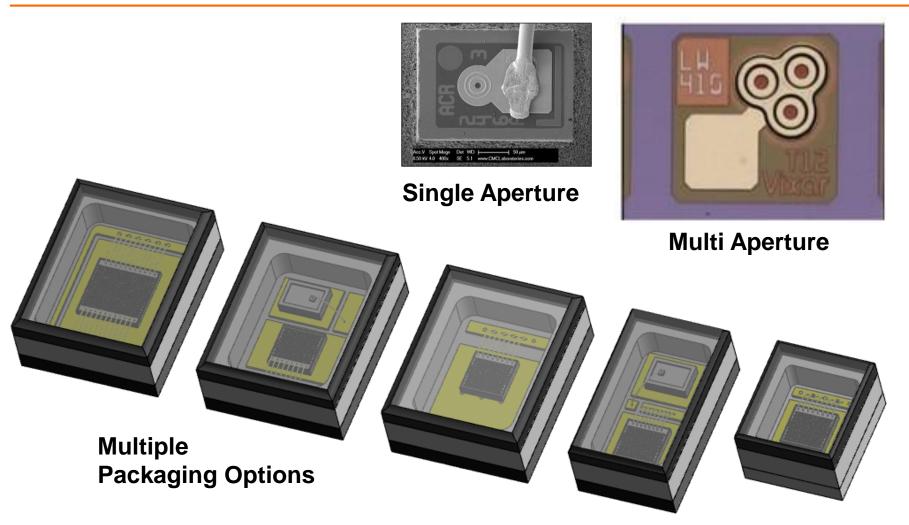


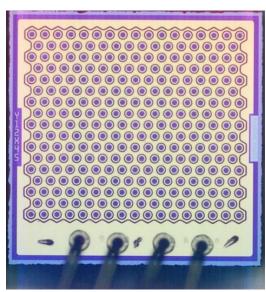
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VCSEL Product Portfolio

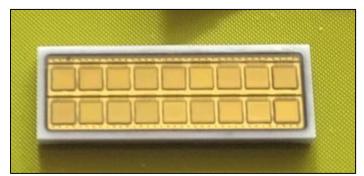


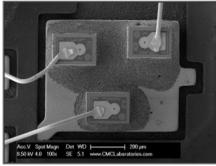


Power Arrays

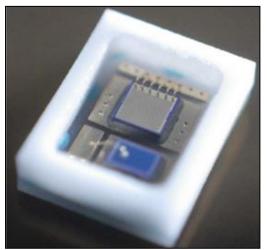


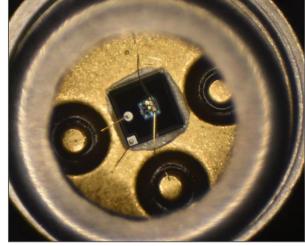
Custom VCSEL Solutions



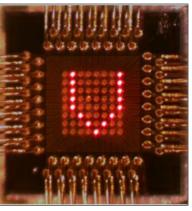


Custom Arrays & Packaging

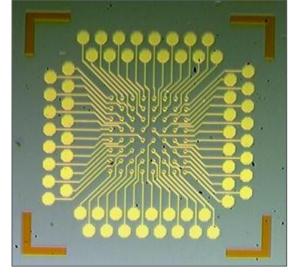


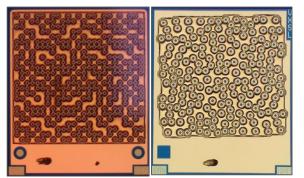


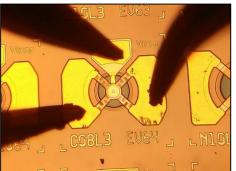
Module integration – PD / TECs / ESD Diodes



Individual Addressability







Custom Die Layouts



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3D Sensing and Imaging Markets and Applications

Consumer



- Face ID for personal security
- Photography assistance, e.g. bokeh
- CAD file input

Industrial



- Robotic vision
- CAD file input
- Distance sensing for safety and automation control

Automotive

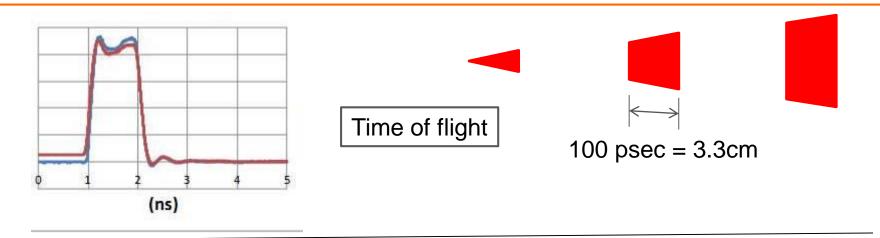


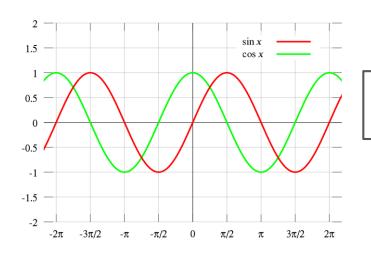
- Driver monitoring (interior)
- Gesture recognition (interior)
- Collision avoidance (external)



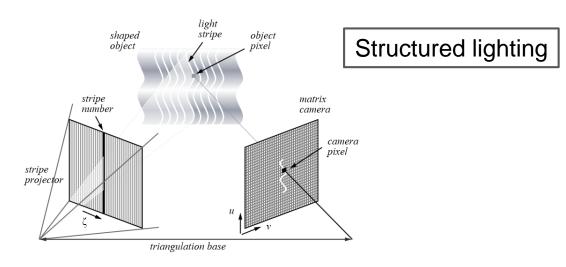
Sensing Mechanisms:

3D Sensing/Gesture Recognition



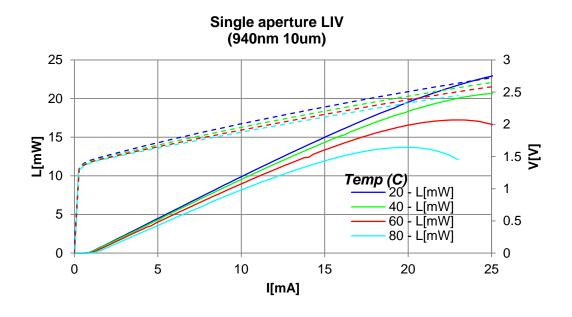


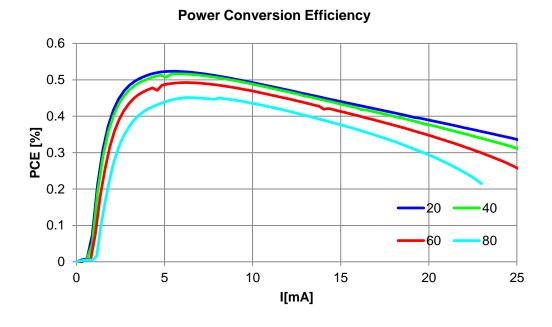
Modulated phase shift





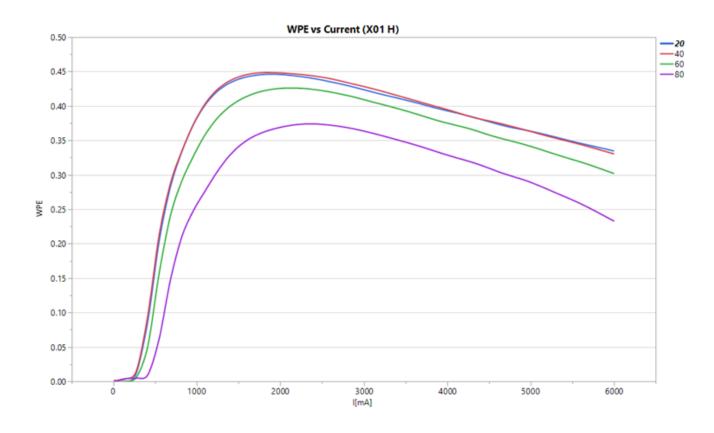
940nm 53% Power Conversion Efficiency

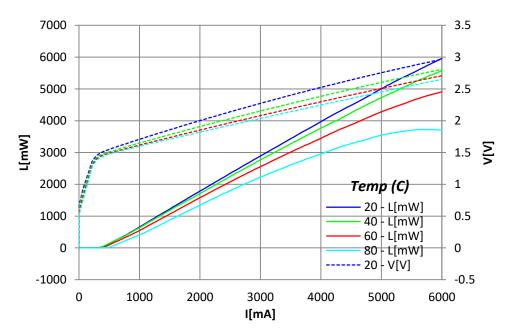






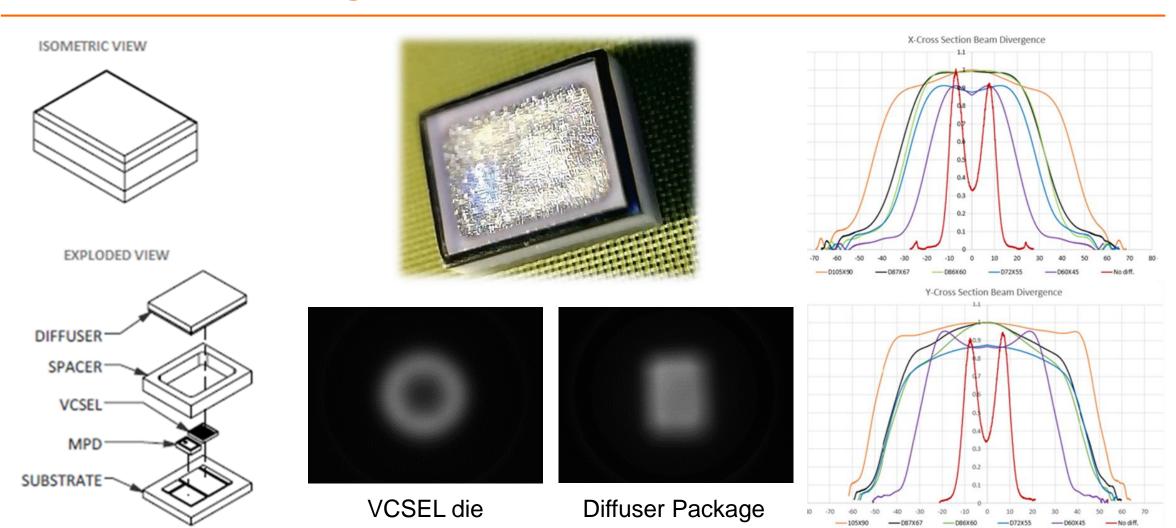
3W VCSEL Array







VCSEL Ceramic Package – Diffusers



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Alternate VCSEL Technology and Applications

Industrial applications

- Atomic clock and self-mixing sensing mechanisms
- Single-mode VCSELs for atomic clocks
- Single-mode VCSELs for self-mixing

Medical applications

- Absorption, fluorescence and scattering mechanisms
- Red VCSEL performance
- Tunable VCSELs
- Integration

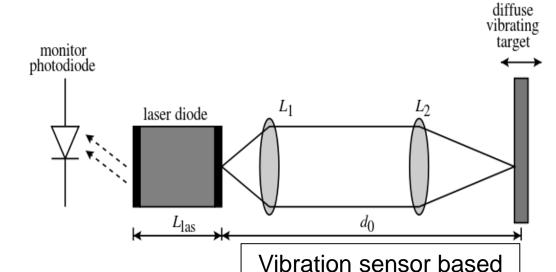


Target Applications

Industrial



Chip scale atomic clock



By Krishnavedala - Own work, CC BY-SA 4.0, https://commons.wikimedia.org/w/index.php?

on self-mixing

Vixar Value Proposition

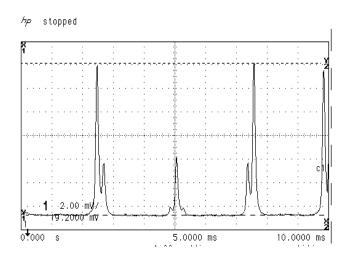
- Power Efficiency
- Miniaturization
- Higher performance due to:
 - Narrow spectrum
 - Ease of beam shaping
- Short pulse width for LIDAR/Time of Flight

Sensing Mechanisms:

Atomic Absorption, Interferometry and Self-Mixing

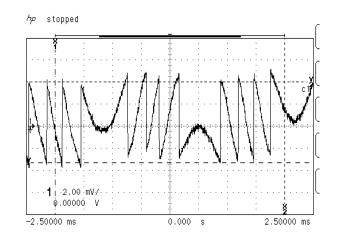
Atomic sensing:

- Magnetometer
- High accuracy time clock



Motion tracking with self-mixing effect:

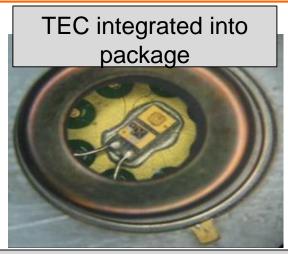
- Light scattered back into the laser causes self-mixing
- Each oscillation corresponds to movement of <1µm



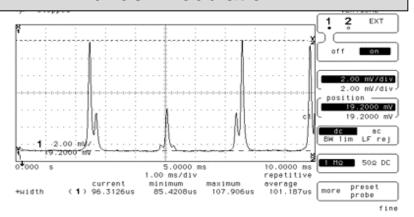
Senses: Rotation Vibration Speech



795/895/940nm single-mode VCSELs for atomic sensors, interferometry, and self-mixing



< 50MHz Linewidth and sidebands under modulation

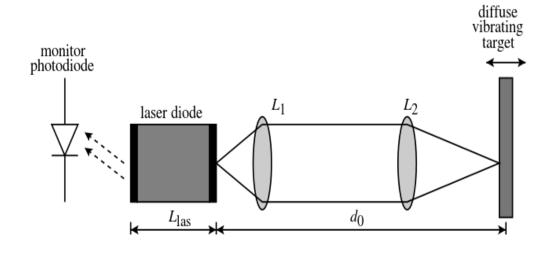


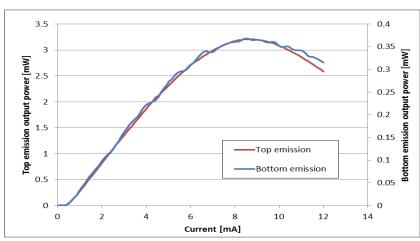
Stable, linear polarization

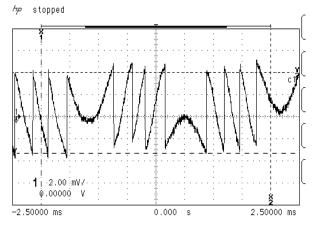


A 940nm VCSEL with back monitor diode









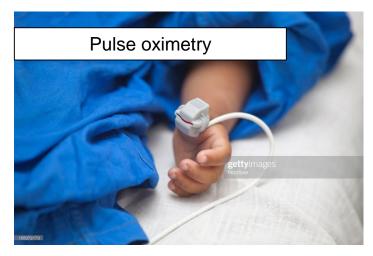
Benefits

- Monitoring for eye safety
- Monitoring to optimize S/N
- Tracking self-mixing signal



Target Applications

Medical







- Power Efficiency
- Compact packaging
- Improved image: narrow spectrum and reduced speckle



Medical diagnostics and imaging



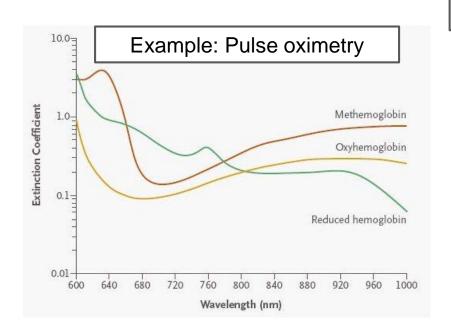
Sensing Mechanism:

Absorption / Fluorescence / Scattering

Absorption:

Narrow spectrum sources can be used to probe an absorption profile

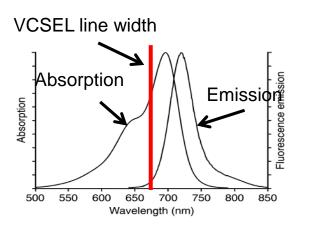
- Medical diagnostics
- Chemical or environmental sensing



Fluorescence:

Excites fluorescence with a narrow spectral linewidth that doesn't interfere with the emission wavelength

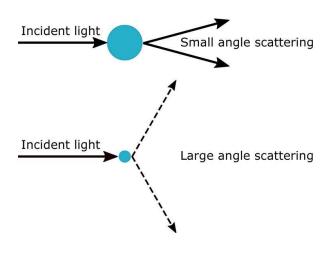
- Medical diagnostics
- Chemical or environmental sensing



Scattering:

Particle size affects scattering pattern

- Particle count
- Particle size distribution analysis





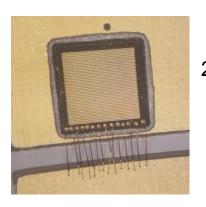
Single Aperture Red VCSELs (680nm)



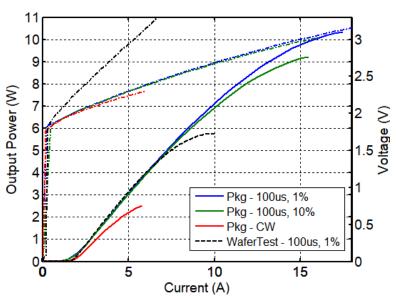
- Manually measured LIV characteristics for single-aperture test structures on 680nm wafer
 - Test conditions were continuous wave (CW) at room temperature (25C)
 - Observed successful lasing for VCSEL aperture sizes between 3 & 20um diameter
- Peak performance for 10um aperture was 34% power conversion efficiency at 4.5mW output power

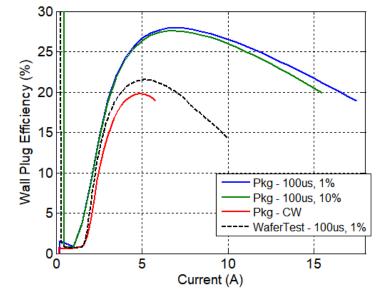


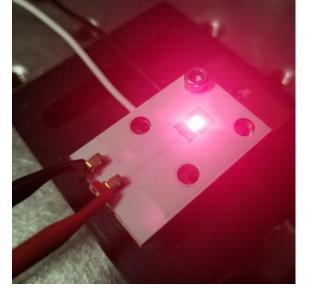
Red 680nm VCSEL High Power Array



2mmx2mm die size



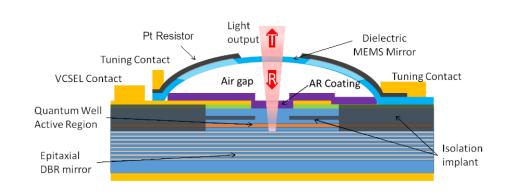


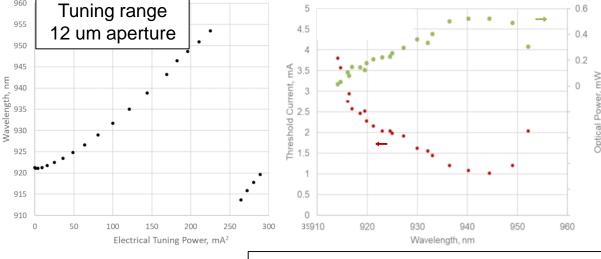


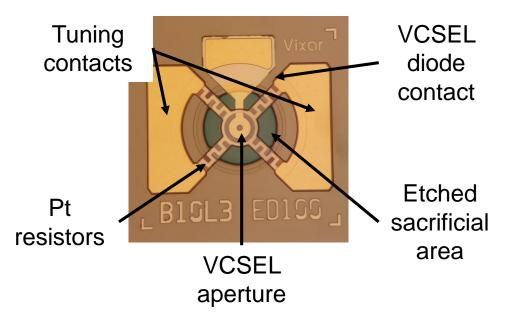


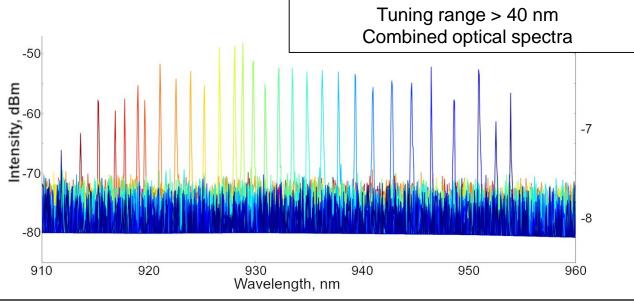
Tunable VCSEL, 940 nm center

Optical Power and I threshold









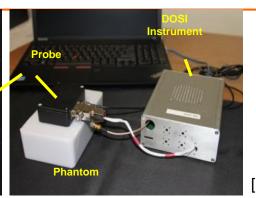




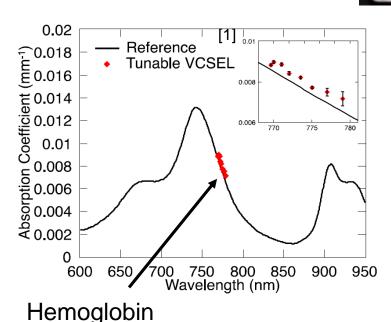
Diffuse Optical Spectroscopic Imaging (DOSI)

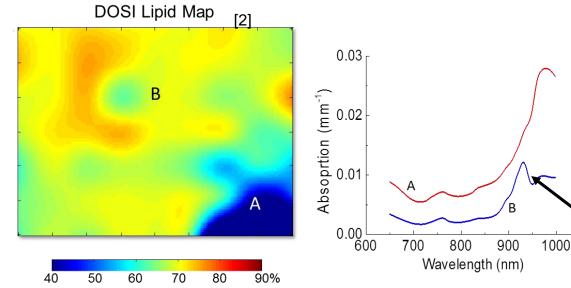
- Image tissue abnormalities without invasive biopsies
- Hand held device with VCSELs
- Fast bandwidth for tuning could lead to near real time scanning of tumor behavior

APD Module



Near-IR tissue absorbers [1]: 785 – 820 nm hemoglobin 910 – 950 nm lipid 950 – 1000 nm water



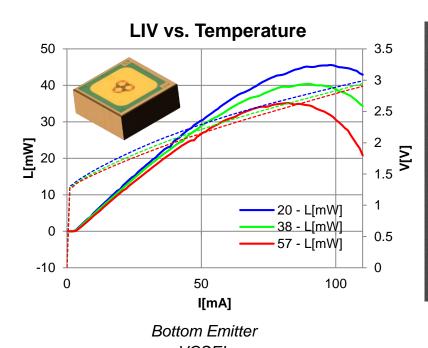


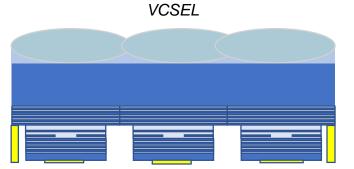
% lipid concentration
Data and images provided by our collaborator Prof. T. O'Sullivan from University of Notre Dame, IN, USA

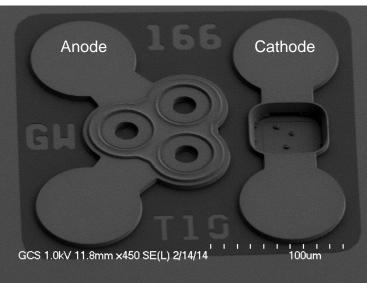


Lipid

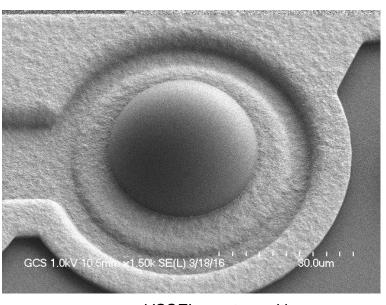
Integration Technologies







Top Emitter VCSEL Flip Chip Co-planar contact



VCSEL aperture with integrated lens

Summary

- ✓ Vixar is experienced with bottom emitting VCSEL process already today.
- ✓ Vixar has developed flip chip experience already
- ✓ Vixar is familiar with integrated optics on aperture level.



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Future Challenges: Technology and Applications

Category	Technology extension	Example application area	Challenge
Wavelength	> 1µm (e.g. 1310, 1550nm	Larger range of LiDAR, environmental	Materials
	Visible (blue, green)	Displays: Augmented and virtual reality	Materials
	Tunable	Environmental and medical sensors, medical imaging	Stability
Packaging	For higher power arrays	LiDAR, laser therapy	Heat sinking capability
	Low cost optical packaging	Many	Solder reflow compatibility; assembly and alignment
	Eye safety measures	Everything	Cost
Integration	Addressable arrays	Communication, displays, power management	Interconnects for large arrays
	Multi-function (VCSEL, PD, driver, optics)	Mobile; wearables	Cost benefit



Future Challenges: Manufacturing and Cost

Category	Improvement needed	Challenge
Die cost	Labor	Not much leverage
	Capital costs	Insource/outsource; time efficiency
	Yield	Substrate defects; process uniformity, process automation
	Chip area	Interconnect schemes, thermal heat dissipation
	Wafer size	Requires the whole ecosystem to shift
Other manufacturing issues	Reliability for large arrays	Substrate and process defects; redundancy
	Reliability for high current density	Substrate and process defects; thermal package design
	Multi-function integration	Designs for minimizing process steps and chip size



This presentation was presented at EPIC Meeting on VCSELs Technology and Applications 2019

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